FORM PTO-1449 U.S. DEPA		RTMENT OF COMMERCE	ATTY. DOCKET NO. H1508			SERIAL NO Not yet assigned		
PATENT AND TRADEMARK OFFICE						18/697		
INFORMATION DISCLOSURE STATEMENT BY APPLICANT				APPLICANT Christine Hau-Riege, et al.				
(Use several sheets if necessary)			FILING DATE Herewith 29 PCTØ 3			GROUP 2823		
				U.S. PATENT DOCUME	ENTS	-	•	
EXAMINI INITIAL	ER	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE	
9/B	\dashv	6,245,996	06/12/01	Atakov,et al.	174	68.1	<u> </u>	
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EXAMINER William M. Brewates							DATE 9 DECA	